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# STL7N6F7



# N-channel 60 V, 21 mΩ typ., 7 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 2x2 package

Datasheet - production data

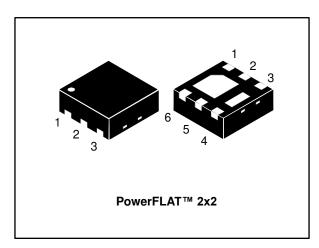
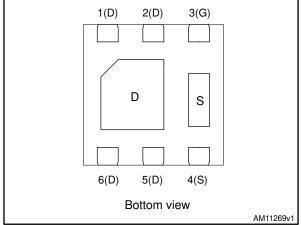


Figure 1: Internal schematic diagram



### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max	ΙD
STL7N6F7	60 V	25 mΩ	7 A

- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent FoM (figure of merit)
- Low C<sub>rss</sub>/C<sub>iss</sub> ratio for EMI immunity
- High avalanche ruggedness

## **Applications**

Switching applications

## **Description**

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

Order code	Marking	Package	Packing
STL7N6F7	ST7N	PowerFLAT™ 2x2	Tape and reel

Contents STL7N6F7

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STL7N6F7 Electrical ratings

# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	60	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) at T <sub>pcb</sub> = 25 °C	7	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>pcb</sub> = 100 °C	4.5	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	28	Α
Ртот	Total dissipation at T <sub>pcb</sub> = 25 °C	2.4	W
TJ	T <sub>J</sub> Operating junction temperature range		00
T <sub>stg</sub>	Storage temperature range	-55 to 150 °C	

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-pcb</sub> <sup>(1)</sup>	Thermal resistance junction-pcb	52	°C/W

## Notes:

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area.

 $<sup>^{(1)}\!</sup>When$  mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

Electrical characteristics STL7N6F7

## 2 Electrical characteristics

(T<sub>C</sub> = 25 °C unless otherwise specified)

Table 4: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1$ mA, $V_{GS} = 0$ V	60			V
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V$ , $V_{DS} = 60 V$			1	μΑ
lgss	Gate-body leakage current	V <sub>G</sub> S = 20 V, V <sub>D</sub> S = 0 V			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 3.5A		21	25	mΩ

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		1	420	1	pF
Coss	Output capacitance	$V_{DS} = 30 \text{ V}, f = 1 \text{ MHz},$	1	215	ı	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$	1	16	1	pF
Qg	Total gate charge	$V_{DD} = 30 \text{ V}, I_{D} = 7 \text{ A}$	1	8	1	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V (see Figure 14: "Test circuit	-	2.3	-	nC
$Q_{gd}$	Gate-drain charge	for gate charge behavior")	-	2.1	-	nC

### Table 6: Switching times

<b>g</b>						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 30 \text{ V}, I_D = 3.5A,$	-	7.85	-	ns
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 13: "Test circuit	-	3.25	-	ns
t <sub>d(off)</sub>	Turn-off delay time	for resistive load switching	1	12.1	1	ns
t <sub>f</sub>	Fall time	times" and Figure 18: "Switching time waveform")	-	3.95	-	ns

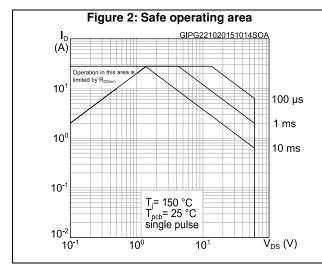
Table 7: Source-drain diode

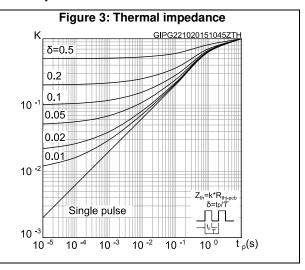
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 7 A, V <sub>GS</sub> = 0 V	-		1.2	V
t <sub>rr</sub>	Reverse recovery time	$I_D = 7 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	17.1		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 48 V (see <i>Figure 15: "Test circuit</i>	-	6.67		nC
I <sub>RRM</sub>	Reverse recovery current	for inductive load switching and diode recovery times"	-	0.8		Α

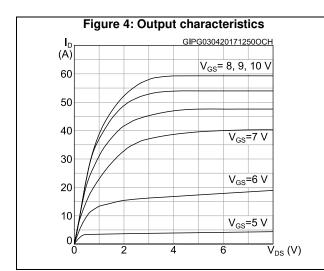
### Notes:

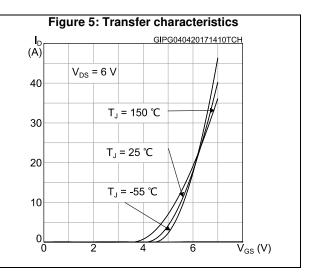
 $<sup>^{(1)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

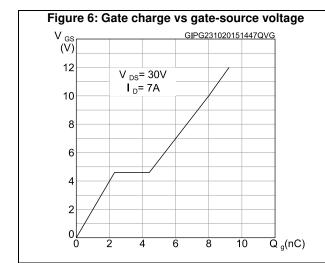
# 2.1 Electrical characteristics (curves)











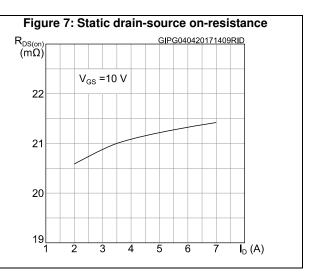


Figure 8: Capacitance variations

C
(pF)

10<sup>2</sup>

f = 1 MHz

10<sup>1</sup>

C<sub>RSS</sub>

C<sub>RSS</sub>

10<sup>0</sup>

10<sup>-1</sup>

10<sup>0</sup>

10<sup>1</sup>

V<sub>DS</sub> (V)

Figure 9: Normalized gate threshold voltage vs temperature V<sub>GS(th)</sub> (norm.) GIPD271020151425VTH 1.15  $I_D = 250 \, \mu A$ 1.1 1.05 0.95 0.9 0.85 0.8 0.75 25 75 -25 125 T<sub>i</sub> (°C)

Figure 10: Normalized on-resistance vs temperature

R DS(on) (norm.)

1.8

V GS= 10 V

I D= 3.5 A

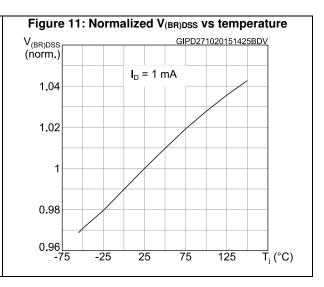
1.4

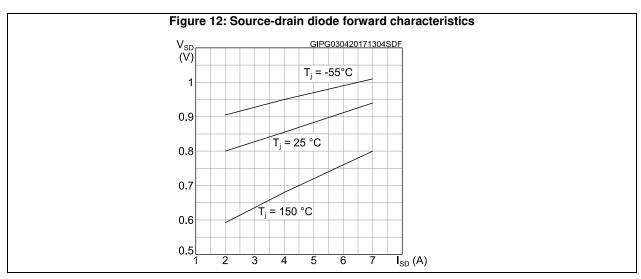
1

0.6

0.2

-75 -25 25 75 125 T (°C)





Test circuits STL7N6F7

## 3 Test circuits

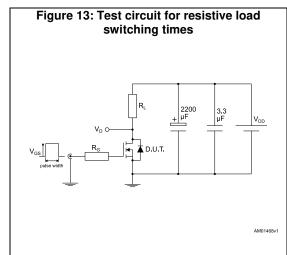


Figure 14: Test circuit for gate charge behavior

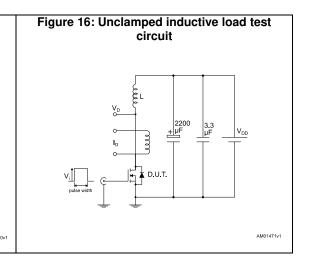
12 V 47 KΩ 100 Ω D.U.T.

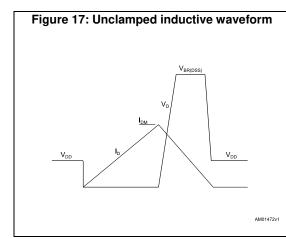
12 V 47 KΩ VG

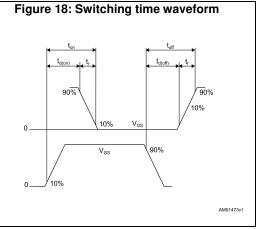
14 KΩ VG

AM01468v1

Figure 15: Test circuit for inductive load switching and diode recovery times







STL7N6F7 Package information

# 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



# 4.1 PowerFLAT 2x2 package information

Figure 19: PowerFLAT™ 2x2 package outline

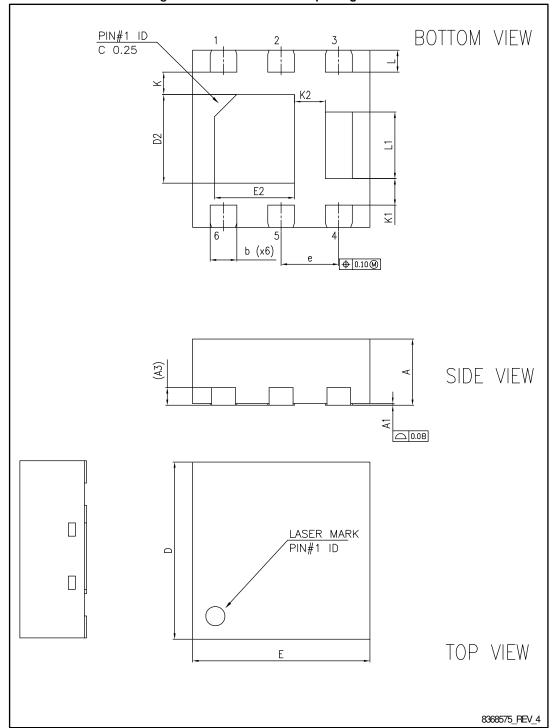
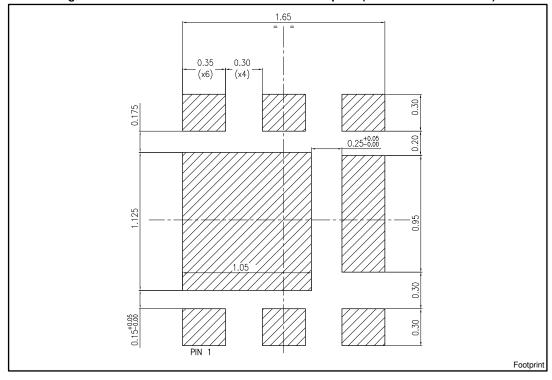


Table 8: PowerFLAT™ 2x2 mechanical data

	Tubic o. I owell EAT	ZXZ IIICCIIdilicai data	
Dim.		mm	
Dilli.	Min.	Тур.	Max.
Α	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3		0.20	
b	0.25	0.30	0.35
D	1.90	2.00	2.10
Е	1.90	2.00	2.10
D2	0.90	1.00	1.10
E2	0.80	0.90	1.00
е	0.55	0.65	0.75
K	0.15	0.25	0.35
K1	0.20	0.30	0.40
K2	0.25	0.35	0.45
L	0.20	0.25	0.30
L1	0.65	0.75	0.85

Figure 20: PowerFLAT™ 2x2 recommended footprint (dimensions are in mm)



Revision history STL7N6F7

# 5 Revision history

12/13

Table 9: Document revision history

Date	Revision	Changes
27-Aug-2015	1	First release.
22-Oct-2015	2	Updated title and features in cover page Updated Table 4: "On /off states", Table 5: "Dynamic" and Table 6: "Switching times".  Added Section 4.1: "Electrical characteristics (curves)"
03-Apr-2017	3	Modified title and features table on cover page Modified Table 4: "On /off states"  Modified Figure 4: "Output characteristics", Figure 5: "Transfer characteristics", Figure 7: "Static drain-source on-resistance" and Figure 12: "Source-drain diode forward characteristics"  Minor text changes.

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